

## IMPI 58 REGISTRANTS AS OF MAY 23, 2024

Badge First Name	Badge Last Name	Badge Organization
Zach	Adams	Worcester Polytechnic Institute
Nathan	Ashcraft	Transform Materials
Xinwei	Bai	NETL
Benjamin	Ballart	SAIREM
Casey	Barber	Rivendell LLC
Bob	Barnum	Cecilia Energy, Inc.
Aman	Bashu	Carnegie Mellon University
Klaus	Baumgärtner	Muegge GmbH
Ben	Beem	AMTek
Jean-Paul	Bernard	Microwave Industrial Solutions
Caterina	Bernardini	University of Padua
Brian	Blackwell	Odyssey Technical Solutions
Glenn	Blaker	PSC, Inc.
Tom	Blassick	Richardson
John	Bows	Pepsico
Raymond	Boxman	Tel Aviv University
Graham	Brodie	James Cook University
Eric	Brown	Conagra Brands
Ralph	Bruce	RWBruce Associates LLC
Graeme	Bunce	Symphony Microwave
Anna Maria	Cavazzini	University of Padova
Kathryn	Carpenter	Cecilia Energy
Jiajia	Chen	University of Tennessee
Morgan	Chen	Carnegie Mellon University
Yu-Ting	Cheng	Cecilia Energy
Grace	Cho	RFHIC Corporation
Kevin	Cho	RFHIC Corporation
Samuel	Cho	RFHIC Corporation
Jamie	Clark	Microwave Amps Ltd.
Zane	Cohick	Air Force Research Laboratory
Wes	Conroy	QWave Solutions

Edward	Cook	ACP Inc.
Jerome	Czajkowski	Richardson
Christie	Denmead	Cubic Defence Australia Pty Ltd
Henry	Downs	Microwave Techniques, LLC
Michael	Druga	SinnovaTek, Inc.
Candice	Ellison	USDA - ARS
Ulrich	Erle	Nestlé R&D
Tom	Finnerty	TRUMPF Huettinger GmbH + Co. KG
Mark	Fitzgerald	Symphony Microwave
Marco	Fiore	Leanfa Srl
Vanessa	Garcia Dizz	INOVA Lab SRL
Francesco	Garuti	MKS
John F.	Gerling	Gerling Consulting, Inc.
Yonas	Gezahegn	Nestle
Arjun	Ghimire	University of Tennessee, Knoxville
Chris	Gruber	Panasonic
Jay	Guilmette	Microwave Techniques, LLC
Amandine	Guissart	Muegge GmbH
Donald	Haislet	TRUMPF Huettinger GmbH + Co. KG
Jon	Hamilton	Teledyne Brown Engineering
Taylor	Hartwright	Rivendell LLC
Yoon Ki	Hong	SAIREM
Ryo	Ishibashi	The University of Tokyo
B. Reeja	Jayan	Carnegie Mellon University
Marie	Jirsa	Mw Consultant
Adam	Jones	Crescend Technologies
Mohammad	Kamarehi	MKS
Ken	Kaplan	Cellencor
Sam	Kim	RFHIC Corporation
Hal	Kimrey	Microwave Materials Technologies, Inc.
Fuminao	Kishimoto	The University of Tokyo
Denis	Kohlhagen	Communication Power Corporation
Phil	Knights	RfMW

Peter	Kuring	Werlatone
Louie	Latrasse	SAIREM
KiWook (Daniel)	Lee	WAVEPIA
Stephen	Leone	Mini-Circuits
Brent	Leier	Aurora Hydrogen
Michael	Luethi	Muegge GmbH
Nadim	Maluf	QWave Solutions
Olaf	Markert	PSC, Inc.
Vladimir	Martinez	Graphic Packaging International
John	Mastela	JFM Technical Corporation
Sean	McKeown	Graphic Packaging International
Mitchell	McLeod	Stellant Systems
Anthony	Megalla	Cecilia Energy
Jonathan	Mullaney	Microwave Techniques, LLC
Cesar	Nieves	Air Force Research Laboratory
Brandon	Noe	Boston Government Services
Marzena	Olszewska-Placha	QWED
Geoff	Paul	AGP Dynamic Solutions Inc.
Edgar	Perez-Lopez	Muegge Gerling
Molly	Poisant	IMPI
Lucas	Poppe	Teledyne Brown Engineering
Nandhakishore	Rajagopalan	National Research Council of Canada (NRC)
Vasileios	Ramopoulos	TRUMPF Huettinger GmbH + Co. KG
Mark	Robertson	Rivendell LLC
Adam	Ritscher	Ampleon
Roger	Ruan	University of Minnesota
Pablo	Santón	pinkRF
Steven	Schlaegle	QWave Solutions
Jacob	Slaughaupt	QWave Solutions
Benjamin	Shassere	Y-12 National Security Complex
Alicia	Standridge	IMPI
Greg	Stromotich	Nuwave Research Inc.
Jacob	Sturgis	Microwave Techniques, LLC

Owen	Stutts	3D RF Energy Corporation
Mark	Taylor	Crescend Technologies
Bas	Terbonssen	Ampleon
Burt	Tilley	Worcester Polytechnic Institute
Tim	Tillford	University of Greenwich
Samir	Trabelsi	USDA-ARS
Richard	Troiano	QWave Solutions
Shuntaro	Tsubaki	Kyushu University
Francois	Van der Merwe	Aurora Hydrogen
Aniruddh	Vashisth	University of Washington
David	Vennin	SAIREM
Rocco	Wall	Stellant Systems
Charles	Wang	Kraft Heinz Corporation
Volkert	Wagenaar	pinkRF
Klaus	Werner	pinkRF
Jerry	Wessel	Richardson
Christina	Wildfire	NETL
Roger	Williams	3D RF Energy Corporation
Wynne	Williams	3D RF Energy Corporation
Michael	Worthington	Stellant Systems
Ajitesh	Yadav	Alkar
Ran	Yang	University of Tennessee